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APR 28 2006

Atty. Docket No. PLA31221/DBE/US

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF:

Kyung Hee Koh

:

: GROUP ART UNIT: 2818

APPLICATION NO: 10/751,200

:

FILED: December 30, 2003

: EXAMINER: Luu, Chuong A.

FOR: METHOD FOR PACKAGING A
MULTI-CHIP MODULE OF A
SEMICONDUCTOR DEVICE

I hereby certify that this document is being facsimile transmitted to the USPTO or deposited with the United States Postal Service as first class mail in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on April 28, 2006.

By: Cindy Custer
Cindy CusterAMENDMENT AND REQUEST FOR RECONSIDERATION UNDER 35 U.S.C. 132
AND 37 C.F.R. 1.111

Mail Stop AMENDMENT
COMMISSIONER FOR PATENTS
P.O. BOX 1450
ALEXANDRIA, VA 22313-1450

SIR:

Responsive to the Office Action dated December 28, 2005, Applicant respectfully requests reconsideration of the above-identified application in view of the following remarks.